

TC2411
14-Bit, 1 GSPS Digital-to-Analog Converter
with Standby Mode of Operation

The TC2411 is a 14-bit, 1 GSPS digital-to-analog converter that delivers exceptional high-frequency performance. The TC2411 is designed to support single or multiple transmit IF signals up to 500 MHz and to deliver superior dynamic range at a sampling rate up to a guaranteed 1 GSPS. A power down feature has been incorporated into the TC2411 which allows the part to be placed into a Standby Mode of operation.

- High resolution
- High Clock rate
- Standby Mode for lower power dissipation

Description

As shown in the functional block diagram below, the TC2411 features a 5-Bit Unary + 9-Bit Binary R2R architecture. 14-bit straight binary data can be input to the DAC at a sample rate of up to 1 GSPS. The DAC provides low-noise and low-spurious performance with digital IF input signals across the first Nyquist band.

The highly linear analog output produced by the TC2411 may be filtered externally to reject the signal image, and is suitable for single-stage upconversion applications.

Applications

The TC2411's high sample rate makes it ideal for the following applications:

- Signal generation
- Direct digital synthesis (DDS)
- Test and measurement
- Software radio
- Single- and multi-carrier transceivers
- Radar (Including Burst mode capability)

Technical Features

- Signal-Noise Ratio.....74dBc @126MHz
- Signal Input.....1000MSPS, 14bits LVDS
- Spur Free Dynamic Range.....75dBc @126MHz
- Clock Input Drive.. 0 to +13dBm, 25Ω differential
- Full Scale Output.....-2dBm, 50Ω differential
- Voltage Reference.....2.5V Bandgap On-Chip
- Power Dissipation1.8W
- Technology0.5 μm SiGe BiCMOS
- Packaging.....96 ball, Pb-free, Cavity-down BGA

Ordering Information

PART NUMBER	TEMP RANGE (°C)	PACKAGE	CLOCK SPEED
TC2411-IB	-40°C to +85°C	96 ball Pb-free BGA	1000 MHz
TC2411-KIT	+25C	Evaluation Kit	

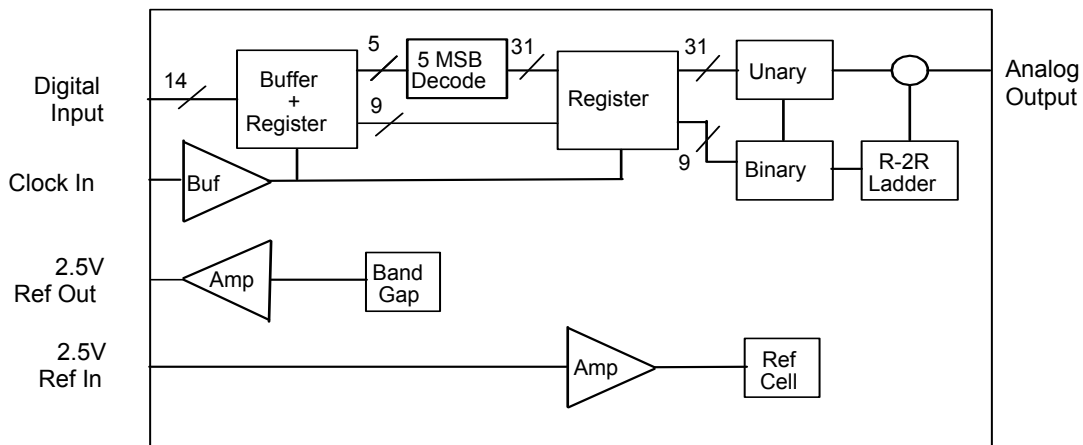


Figure 1: TC2411 Functional Block Diagram

Absolute Maximum Ratings

(Electrical performance is not guaranteed at absolute maximum ratings. Exposure to absolute maximum ratings for an extended period of time may impair the useful life of the product)

Parameter	Max	Unit
Electrical		
+5.0V Supply Voltage AVCC, DVDD	+5.5	V
+3.3V Supply Voltage DVCC	+3.6	V
-5.0V Supply Voltage AVEE, DVEE	-5.5	V
Clock Input Voltage	+4.0	V _{pp}
Environmental		
Operating Temp Range	-40 to +85	°C
Storage Temp Range	-65 to +150	°C
Maximum Junction Temperature	+110	°C
Reflow Soldering Peak Temperature	+260	°C

TC2411 Electrical Specifications

(AVEE, DVEE = -5V; AVCC, DVDD = +5V; DVCC = +3.3V; IOUT = 20 mA, -40°C to +85°C ambient, unless otherwise noted)

DC SPECIFICATIONS	CONDITION	MIN	TYP	MAX	UNITS
Supply Voltages					
AVCC, DVDD		4.75	5.0	5.25	V
DVCC		3.13	3.3	3.46	V
AVEE		-5.25	-5.0	-4.75	V
DVEE		-5.25	-5.0	-4.75	V
Normal Mode					
AVCC + DVDD + DVCC Current			30		mA
AVEE + DVEE Current			330		mA
Power Consumption			1.8		W
Reference Voltage info	V _{out_REF}		2.5		V
Reference Output Load Regulation	0 < I _{source} < I _{max}				mV
Resolution			14		Bits
Standby Mode					
AVCC + DVDD + DVCC Current			40		mA
AVEE + DVEE Current			140		mA
Power Consumption			850		mW

TC2411 Electrical Specifications continued

(AVEE, DVVE = -5V; AVCC, DVDD = +5V; DVCC = +3.3V; IOUT = 20 mA, -40°C to +85°C ambient, unless otherwise noted)

DIGITAL SPECIFICATIONS	CONDITION	MIN	TYP	MAX	UNITS
Logic Inputs (N1- N14, P1 – P14)					
Compatibility	LVDS				
Input Impedance			100		ohms
Common Mode Voltage (VCM)			+1.2		V
Differential Input High Level	VCM = +1.2V			+100	mV
Differential Input Low Level	VCM = +1.2V	-100			mV
Data Coding	Binary				
Switching characteristics					
Setup Time			130		ps
Hold Time			440		ps
Propagation Delay Time			400		ps
Data Rise Time	10% to 90 %		220		ps
Data Fall Time	90% to 10 %		230		ps
Reset (RST)					
High Level			3.3		Volts
Low Level			0		Volts
Pulse Width		2.5			ns
Pulse Repetition Rate		DC		200	MHz
Propagation Delay			3		Clock cycles
Standby Mode (SLP, SLN)					
Single Ended Drive					
Low Level			0		Volts
High Level			3.3		Volts
Differential drive (External 100Ω)					
Low Level			1.0		Volts
High Level			1.4		Volts

ANALOG SPECIFICATIONS	CONDITION	MIN	TYP	MAX	UNITS
DAC Clock (CLKP, CLKN)					
Maximum Conversion Rate	Guaranteed	1000			MSPS
Differential Input Voltage			1.5		V _{pp}
Common-mode Input Voltage			-3.1		V
Differential Input Resistance			25		ohms
Analog Output (VOP, VON)					
Full Scale Output Voltage	20 mA Differential Output Current		0.480		V _{p-p}
Differential Output Resistance			50		ohms

DYNAMIC SPECIFICATIONS	CONDITION	MIN	TYP	MAX	UNITS
DAC Output vs Frequency @ -0.5 dBFS					
$f_{out} = 33$ MHz			-3		dBm
$f_{out} = 126$ MHz			-3		dBm
$f_{out} = 251$ MHz			-5		dBm
$f_{out} = 376$ MHz			-8		dBm
$f_{out} = 490$ MHz			-9		dBm
Noise Spectral Density @ -0.5 dBFS					
$f_{out} = 33$ MHz			-166		dBm/Hz
$f_{out} = 126$ MHz			-164		dBm/Hz
$f_{out} = 251$ MHz			-161		dBm/Hz
$f_{out} = 376$ MHz			-161		dBm/Hz
$f_{out} = 490$ MHz			-160		dBm/Hz
SFDR vs Frequency @ -0.5 dBFS					
$f_{out} = 33$ MHz			-78		dBc
$f_{out} = 126$ MHz			-75		dBc
$f_{out} = 251$ MHz			-70		dBc
$f_{out} = 376$ MHz			-65		dBc
$f_{out} = 490$ MHz			-60		dBc
IMD					
IF = 135 MHz, 145 MHz	2 Tones @ -6.5 dBFS		-82		dBc
IF = 110 MHz, 120 MHz, 130 MHz, 140 MHz	4 Tones @ -12.5 dBFS		-82		dBc
ACPR (EDGE)					
IF = 260 MHz	1 Tone @ -3.5 dBFS		-95		dBc
IF = 230 MHz, 240 MHz, 260 MHz, 270 MHz	4 Tones @ -15.5 dBFS		-88		dBc
ACPR (WCDMA)					
IF = 260 MHz	1 Tone @ -10.5 dBFS		-75		dBc
IF = 230 MHz, 240 MHz, 260 MHz, 270 MHz	4 Tones @ -17.5 dBFS		-76		dBc
Analog Output Response					
Output Settling Time					pS
Output Rise Time (10 - 90%)			220		pS
Output Fall Time (90 - 10%)			230		pS
Glitch Energy					
-FS to +FS transition	FS = Full-Scale		0.5		ps-V
+FS to -FS transition			0.1		ps-V
-MS to +MS transition	MS = Mid-Scale		0.4		ps-V
+MS to -MS transition			0.2		ps-V

TC2411 Thermal Characteristics

Normal Mode of Operation

Package	θ_{JC} ($^{\circ}C/W$)	θ_{JA} ($^{\circ}C/W$)			Note
		0 m/s	2m/s	3m/s	
19X19 Cavity-down BGA 96L	2.72	20.2	18.5	17.5	Results based on FEA simulation without heat sink.

- The DC power of the TC2411 is 1.8 W in normal mode of operation
- Maximum Junction Temperature is not to exceed 110°C.
- There is no need for an external heat sink if maximum ambient temperature is +70°C.
- An external heat sink is recommended for ambient temperatures in excess of +70°C to insure that the junction temperature does not exceed 110°C maximum.
- Use of standby mode reduces the average power dissipation proportional to the normal mode / standby mode duty cycle and allows a higher ambient temperature before a heat sink must be used to insure that the junction temperature does not exceed 110°C maximum.
- In the above table, θ_{JA} is presented according to JEDEC JESD 51-2 (natural convection) and 51-6 (forced convection). Thermal simulation assumes the package is mounted on the test board specified by JEDEC JESD51-9 (101.6X114.3X1.6 mm, four layers).

Note:

θ_{JC} : Thermal resistance from junction to case.

θ_{JA} : Thermal resistance from junction to ambient.

Figure 2: Standby Mode Operational Truth Table

<u>Control Signal</u>	<u>Normal Mode</u>	<u>Standby Mode</u>
STDBY_P	L	H
STDBY_N	H	L

Figure 3: Standby/Normal Mode Timing

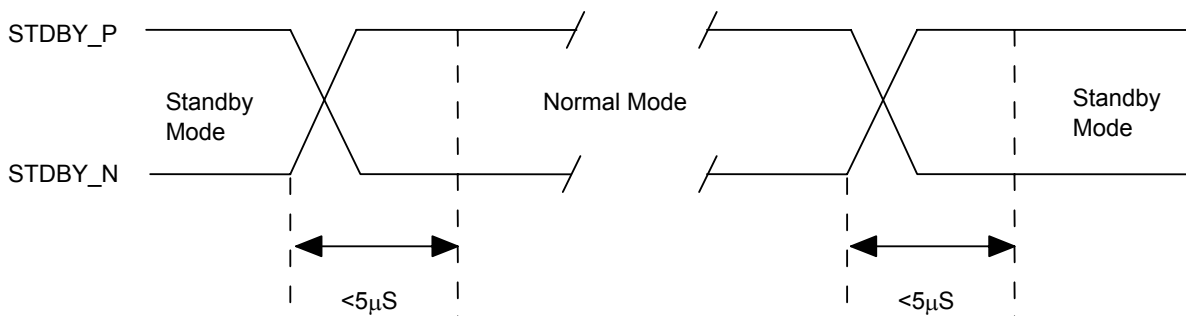


Figure 4: TC2411 Typical Application Circuit

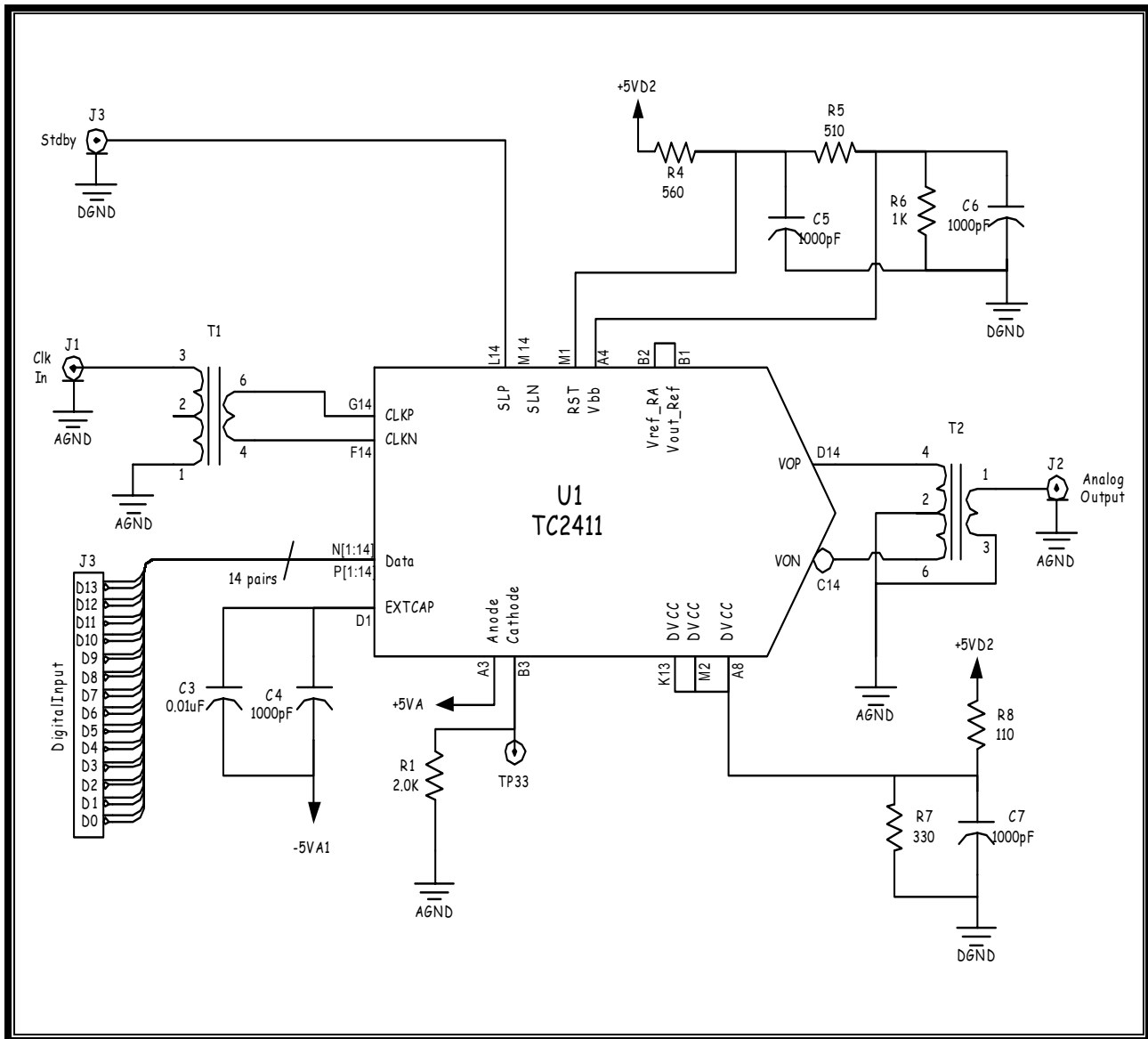
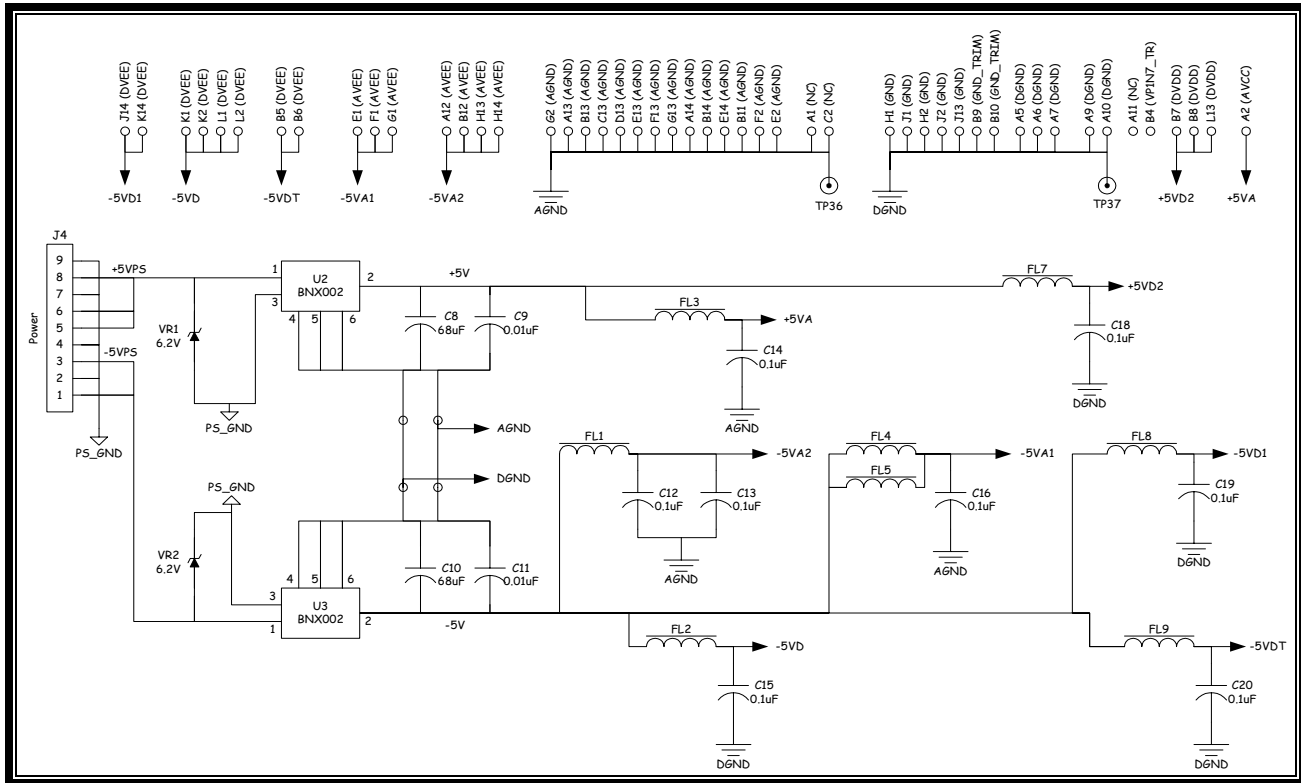


Figure 4 (Cont): TC2411 Typical Application Circuit

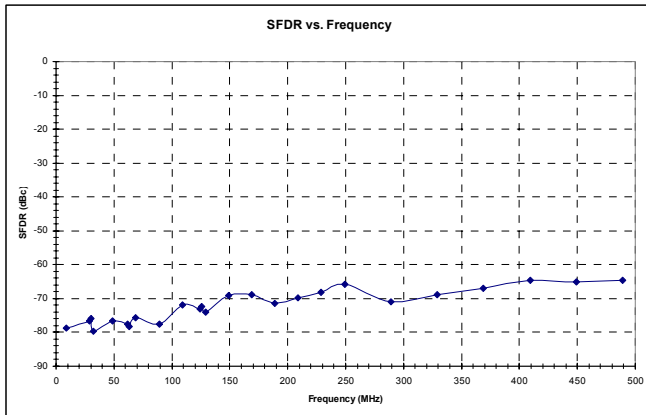


TC2411 Typical Application Circuit Parts List

FIND #	QTY	REFERENCE DESIGNATOR	TYPE	VALUE	TOLERANCE	MANUFACTURER / DESCRIPTION
1	4	C4, C5, C6, C7	Capacitor	1000pF	10%	X7R
2	3	C3, C9, C11	Capacitor	0.01uF	10%	X7R
3	2	C8, C10	Capacitor	68uF	10%	Tantalum
4	8	C12, C13, C14, C15, C16, C18, C19, C20	Capacitor	0.1uF	10%	X7R
5	8	F11, F12, F13, F14, F15, F17, F18, F19	Ferrite Bead	BLM18A G221SN		Murata
6	1	R1	Resistor	2.0K	5%	
7	1	R4	Resistor	560	1%	
8	1	R5	Resistor	510	1%	
9	1	R6	Resistor	1K	2%	
10	1	R7	Resistor	330	2%	
11	1	R8	Resistor	110	2%	
12	1	T1	Transformer	TX-2-5-1	2%	Mini-Circuits, 2:1 impedance ratio
13	1	T2	Transformer	ADT1-1WT	2%	Mini-Circuits, 1:1 impedance ratio
14	1	U1	DAC	TC2411		TelASIC, 14 Bit, 1GHz DAC
15	2	U2, U3	EMI Filter	BNX002		Murata
16	2	VR1, VR2	Zener	6.2V		1 Watt

TC2411 Performance Characteristics

Figure 5: SFDR vs. Frequency @ -0.5 dBFS*



* The values in Figure 1 include coax and filter losses in the setup.

Figure 6: Noise Floor vs. Frequency

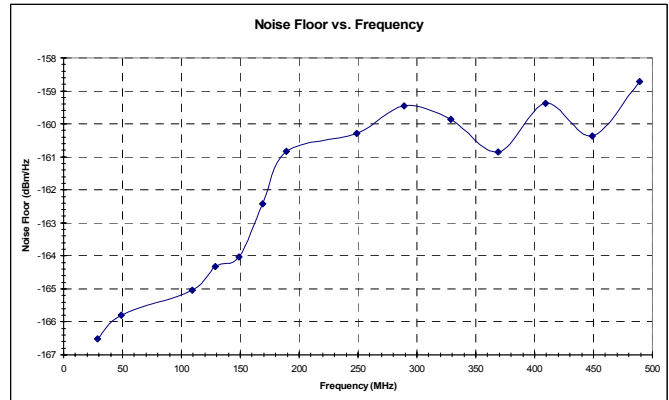


Figure 7: Clock Power Level vs. Noise

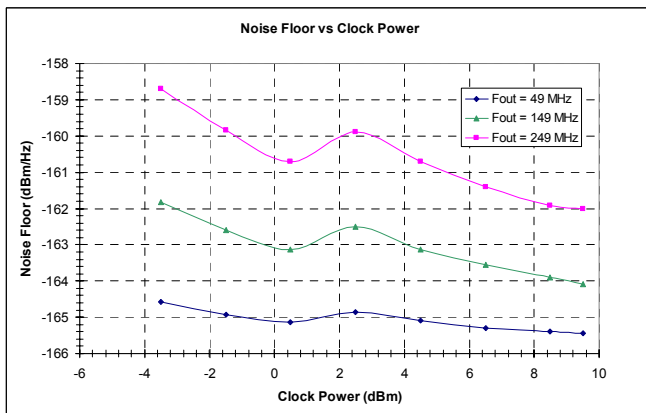


Figure 8: DAC Output Level vs. Frequency

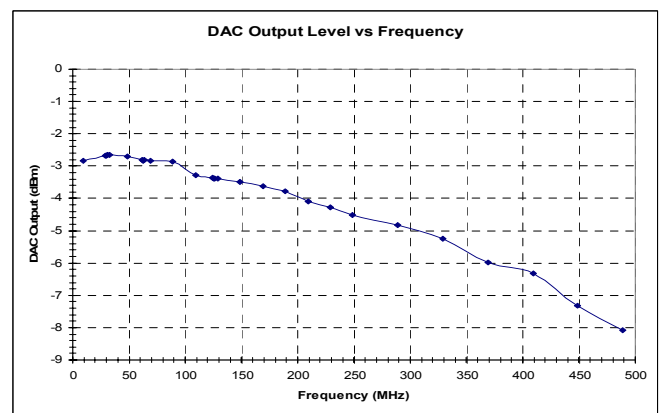


Figure 9: Two tone IMD (dBc) vs. Frequency

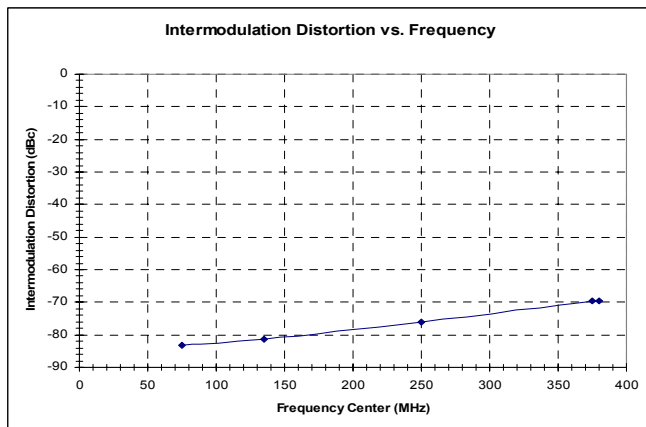


Figure 10: SFDR at 33 MHz (-77 dBc)

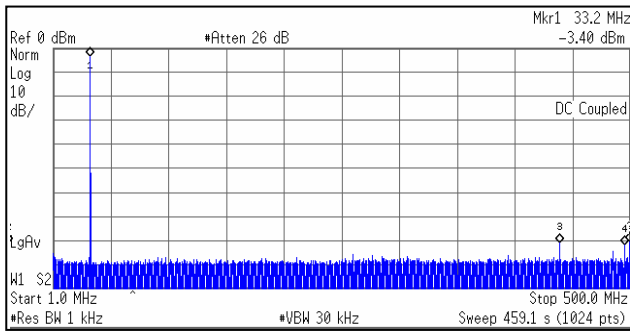


Figure 11: SFDR at 126 MHz (-75 dBc)

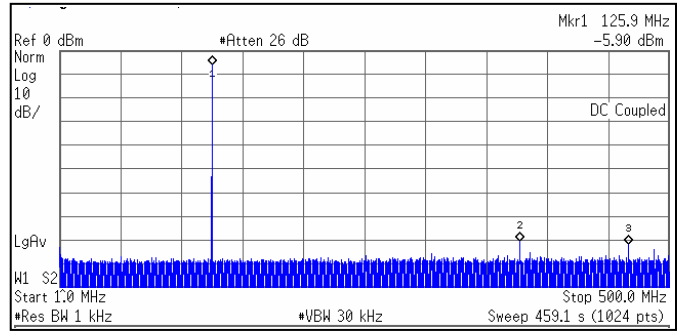


Figure 12: SFDR at 251 MHz (-72 dBc)

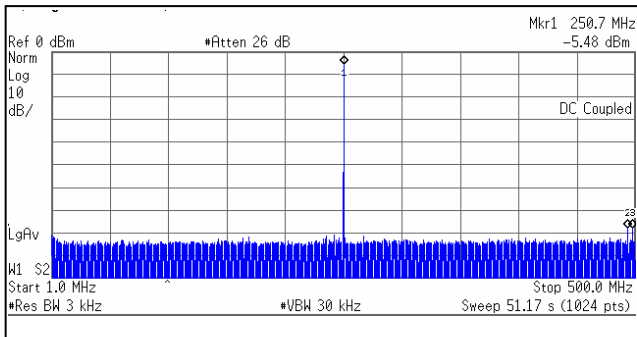


Figure 13: SFDR at 490 MHz (-61 dBc)

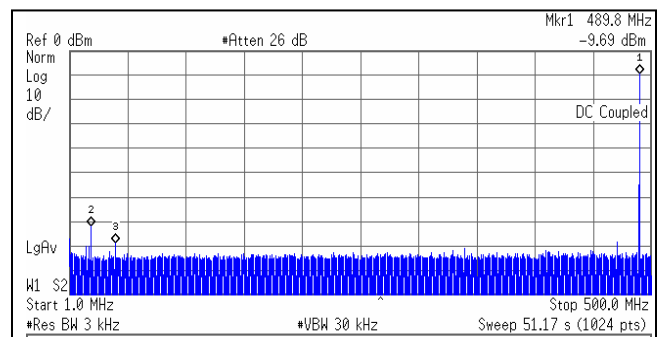


Figure 14: 2-Tone IMD (-82 dBc)*

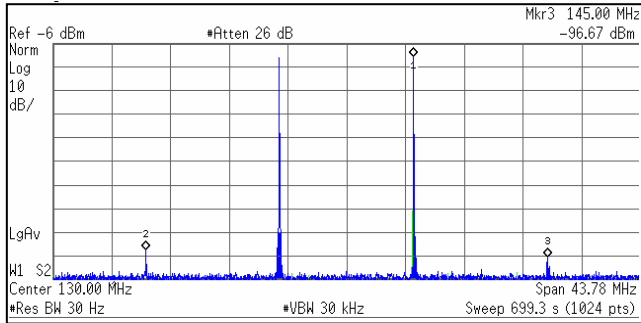


Figure 15: 4-Tone IMD (-82 dBc)*

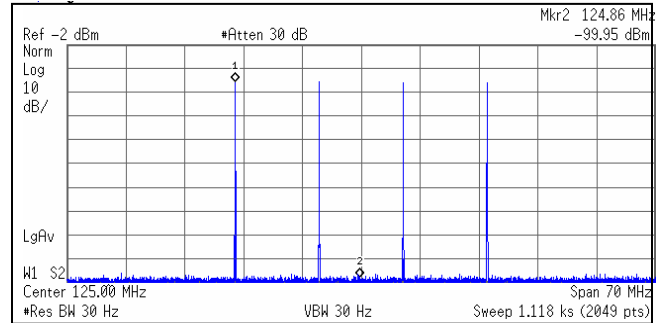
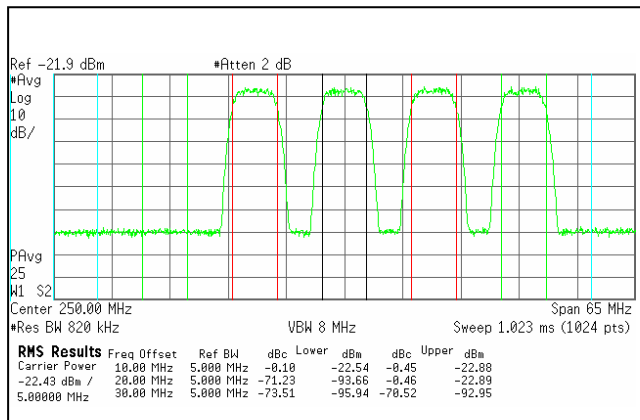


Figure 16: ACPR 4-Tone WCDMA (-76 dBc)*



* listed values indicate the actual measured levels, whereas plots shown here are limited by the instrument dynamic range

Figure 17: TC2411 Timing Diagram

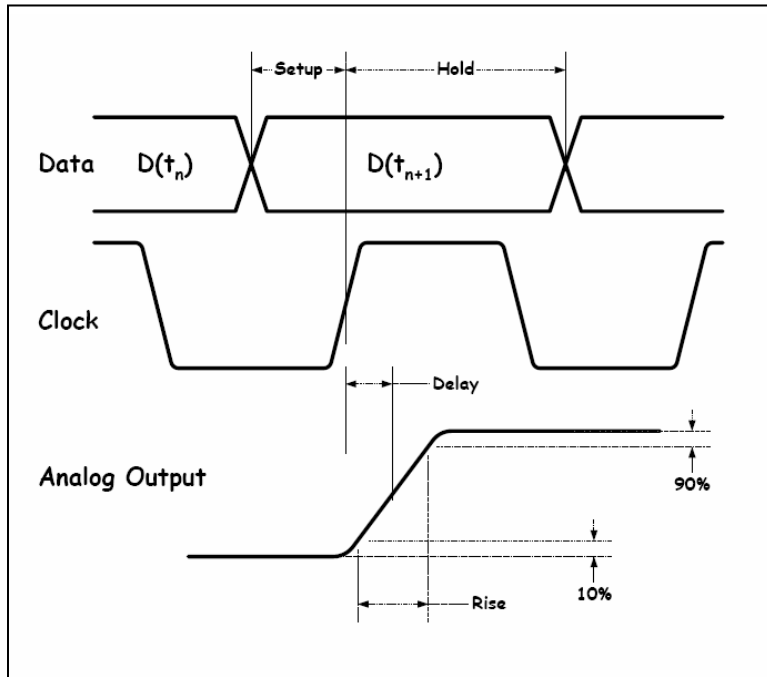


Figure 18: TC2411 Pinouts – 96 Ball Cavity-Down BGA Package (Ball Side UP)

	14	13	12	11	10	9	8	7	6	5	4	3	2	1
A	AGND	AGND	AVEE	NC	DGND	DGND	DVCC	DGND	DGND	DGND	VBB	ANODE	AVCC	AGND
B	AGND	AGND	AVEE	AGND	AGND	AGND	DVDD	DVDD	DVEE	DVEE	VP1N7_ TR	CATHODE	VREF_ RA	VOUT_ REF
C	VON	AGND											AGND	DNC1
D	VOP	AGND											DNC2	EXTCAP
E	AGND	AGND											AGND	AVEE
F	CLKN	AGND											AGND	AVEE
G	CLKP	AGND											AGND	AVEE
H	AVEE	AVEE											DGND	DGND
J	DVEE	DGND											DGND	DGND
K	DVEE	DVCC											DVEE	DVEE
L	SLP	DVDD											DVEE	DVEE
M	SLN	DNC3											DVCC	RST
N	D0P	D1P	D2P	D3P	D4P	D5P	D6P	D7P	D8P	D9P	D10P	D11P	D12P	D13P
P	D0N	D1N	D2N	D3N	D4N	D5N	D6N	D7N	D8N	D9N	D10N	D11N	D12N	D13N

TC2411 I/O Descriptions

PIN	NAME	DESCRIPTION	PIN	NAME	DESCRIPTION
A1	AGND	ANALOG GND	N1	D13P	DATA INPUT BIT 13 (MSB)
A2	AVCC	+5V REF AMP SUPPLY	N2	D12P	DATA INPUT BIT 12
A3	ANODE	ANODE FOR TEMPERATURE DIODE	N3	D11P	DATA INPUT BIT 11
A4	VBB	+2.4V Bias	N4	D10P	DATA INPUT BIT 10
A5	DGND	DIGITAL GND	N5	D9P	DATA INPUT BIT 9
A6	DGND	DIGITAL GND	N6	D8P	DATA INPUT BIT 8
A7	DGND	DIGITAL GND	N7	D7P	DATA INPUT BIT 7
A8	DVCC	+3.3V SUPPLY FOR ESD	N8	D6P	DATA INPUT BIT 6
A9	DGND	DIGITAL GND	N9	D5P	DATA INPUT BIT 5
A10	DGND	DIGITAL GND	N10	D4P	DATA INPUT BIT 4
A11	NC	NO CONNECT	N11	D3P	DATA INPUT BIT 3
A12	AVNS	-5V ANALOG SUPPLY	N12	D2P	DATA INPUT BIT 2
A13	AGND	ANALOG GND	N13	D1P	DATA INPUT BIT 1
A14	AGND	ANALOG GND	N14	D0P	DATA INPUT BIT 0 (LSB)
B1	VOUT_REF	VOLTAGE REFERENCE OUTPUT, +2.5V	P1	D13N	DATA INPUT BIT 13 – COMPLEMENT (MSB)
B2	VREF_RA	REFAMP INPUT	P2	D12N	DATA INPUT BIT 12 – COMPLEMENT
B3	CATHODE	CATHODE FOR TEMPERATURE DIODE	P3	D11N	DATA INPUT BIT 11 – COMPLEMENT
B4	VP1N7_TR	-1.7V TEST POINT	P4	D10N	DATA INPUT BIT 10 – COMPLEMENT
B5	DVEE	-5V SUPPLY	P5	D9N	DATA INPUT BIT 9 – COMPLEMENT
B6	DVEE	-5V SUPPLY	P6	D8N	DATA INPUT BIT 8 – COMPLEMENT
B7	DVDD	+5V DIGITAL SUPPLY	P7	D7N	DATA INPUT BIT 7 – COMPLEMENT
B8	DVDD	+5V DIGITAL SUPPLY	P8	D6N	DATA INPUT BIT 6 – COMPLEMENT
B9	AGND	ANALOG GND	P9	D5N	DATA INPUT BIT 5 – COMPLEMENT
B10	AGND	ANALOG GND	P10	D4N	DATA INPUT BIT 4 – COMPLEMENT
B11	AGND	ANALOG GND	P11	D3N	DATA INPUT BIT 3 – COMPLEMENT
B12	AVEE	-5V ANALOG SUPPLY	P12	D2N	DATA INPUT BIT 2 – COMPLEMENT
B13	AGND	ANALOG GND	P13	D1N	DATA INPUT BIT 1 – COMPLEMENT
B14	AGND	ANALOG GND	P14	D0N	DATA INPUT BIT 0 – COMPLEMENT (LSB)
C1	DNC1	DO NOT CONNECT	H1	DGND	DIGITAL GND
C2	AGND	ANALOG GND	H2	DGND	DIGITAL GND
C13	AGND	ANALOG GND	H13	AVEE	-5V ANALOG SUPPLY
C14	VON	DAC ANALOG OUPUT – COMPLEMENT	H14	AVEE	-5V ANALOG SUPPLY
D1	EXTCAP	REF AMP BYPASS CAPACITOR	J1	DGND	DIGITAL GND
D2	DNC2	DO NOT CONNECT	J2	DGND	DIGITAL GND
D13	AGND	ANALOG GND	J13	DGND	DIGITAL GND
D14	VOP	DAC ANALOG OUPUT	J14	DVEE	-5V DIGITAL SUPPLY
E1	AVEE	-5V ANALOG SUPPLY	K1	DVEE	-5V DIGITAL SUPPLY
E2	AGND	ANALOG GND	K2	DVEE	-5V DIGITAL SUPPLY
E13	AGND	ANALOG GND	K13	DVCC	+3.3V DIGITAL SUPPLY
E14	AGND	ANALOG GND	K14	DVEE	-5V DIGITAL SUPPLY
F1	AVEE	-5V ANALOG SUPPLY	L1	DVEE	-5V DIGITAL SUPPLY
F2	AGND	ANALOG GND	L2	DVEE	-5V DIGITAL SUPPLY
F13	AGND	ANALOG GND	L13	DVDD	+5V DIGITAL SUPPLY
F14	CLKN	DAC CLOCK INPUT – COMPLEMENT	L14	SLP	STANDBY INPUT
G1	AVEE	-5V ANALOG SUPPLY	M1	RST	RESET/BURST MODE
G2	AGND	ANALOG GND	M2	DVCC	+3.3V SUPPLY FOR ESD
G13	AGND	ANALOG GND	M13	DNC3	DO NOT CONNECT
G14	CLKP	DAC CLOCK INPUT	M14	SLN	STANDBY INPUT - COMPLEMENT

Application Notes:**A. Power Supply Decoupling**

Add power supply decoupling nearby package pins as summarized below:

1. *AVEE* – bypass each group of pins with 0.1 uF capacitor to AGND.
 - a. A12, B12
 - b. E1, F1, G1
 - c. H13, H14
2. *DVEE* – bypass each group of pins with 0.1 uF capacitor to DGND.
 - a. K1, K2, L1, L2
 - b. J14, K14
 - c. B5, B6
3. *DVDD* – bypass each group of pins with 0.1 uF capacitor to DGND.
 - a. B7, B8
 - b. L13
4. *AVCC* – bypass pin A2 with 0.1 uF capacitor to AGND.
5. *DVCC* – bypass pins A8, M2 and K13 with 1000 pF capacitor to DGND.

B. Analog Outputs (VOP, VON)

The TC2411 supplies differential analog DAC outputs at pins VOP and VON. Each pin is internally terminated with 25 ohms to analog ground, creating an effective 50 ohm differential source. When these outputs are connected to a single-ended, 50 ohm load through a 1:1 transformer, the resulting full-scale AC swing is approximately 500 mVpp (20 mA into 25 ohms). Each DAC output may be dc-coupled to a ground-referenced load.

C. Clock Inputs (CLKP, CLKN)

To achieve excellent phase noise performance, the TC2411 requires a differential clock input with low jitter characteristics. A 2:1 transformer may be used to convert a single-ended, 50 ohm clock source and provide a 25 ohm, ac-coupled, differential drive into CLKP and CLKN. These inputs are internally biased and terminated with 12.5 ohms per side.

A very low-phase noise (low jitter) sinewave clock signal should be used for enhanced SNR performance. A sinewave oscillator featuring at least -130 dBc/Hz phase noise, above 20 KHz from the carrier is recommended. Best noise performance is achieved with clock sources capable of 1.5 Vpp or greater outputs.

D. LVDS-Compliant Digital Inputs (D0P/N to D13P/N)

The TC2411 offers an LVDS-compliant interface into the 14 bit data inputs. These inputs are differentially terminated on-chip with 100 ohms. 0000 corresponds to minus full-scale, while 3FFF represents plus full-scale.

E. Reset/Burst Mode (RST)

The TC2411 offers a burst mode capability whereby the DAC analog output can be asynchronously reset to the all zeros code (00 0000 0000 0000) irrespective of input data. Under normal operation, the RST pin should be held high at +3.3V. When a low signal (0V) is applied to RST, the DAC output resets to the all zeros code (minus full scale). Contact TelASIC sales for further information.

F. Temperature Diode (ANODE, CATHODE)

The TC2411 provides an on-chip temperature diode which may be used to monitor die temperature. Applying +5V to the anode pin and measuring the cathode node voltage into a 2K ohm load, the user can convert the resulting voltage into a temperature. Contact TelASIC sales for further information.

G. External Capacitor for Ref Amp (EXTCAP)

The on-chip reference amplifier requires an external capacitor to maintain excellent phase noise and jitter characteristics. Attach two capacitors, 0.01 uF and 1000 pF, in parallel between the EXTCAP pin and -5V analog supply.

H. Ref Amp Input (VREF_RA)

VOUT_REF is an internally generated, +2.5V precision bandgap reference. Tie this output to VREF_RA, the ref amp input.

I. Standby Mode Function (SLP, SLN)

The TC2411 offers a Standby Mode capability whereby the power dissipation is reduced to 850mW. The standby function comes in on pins L14 (SLP) and M14 (SLN). Under normal operation both pins are left floating. This mode may be enabled with either a single-ended drive or a differential drive.

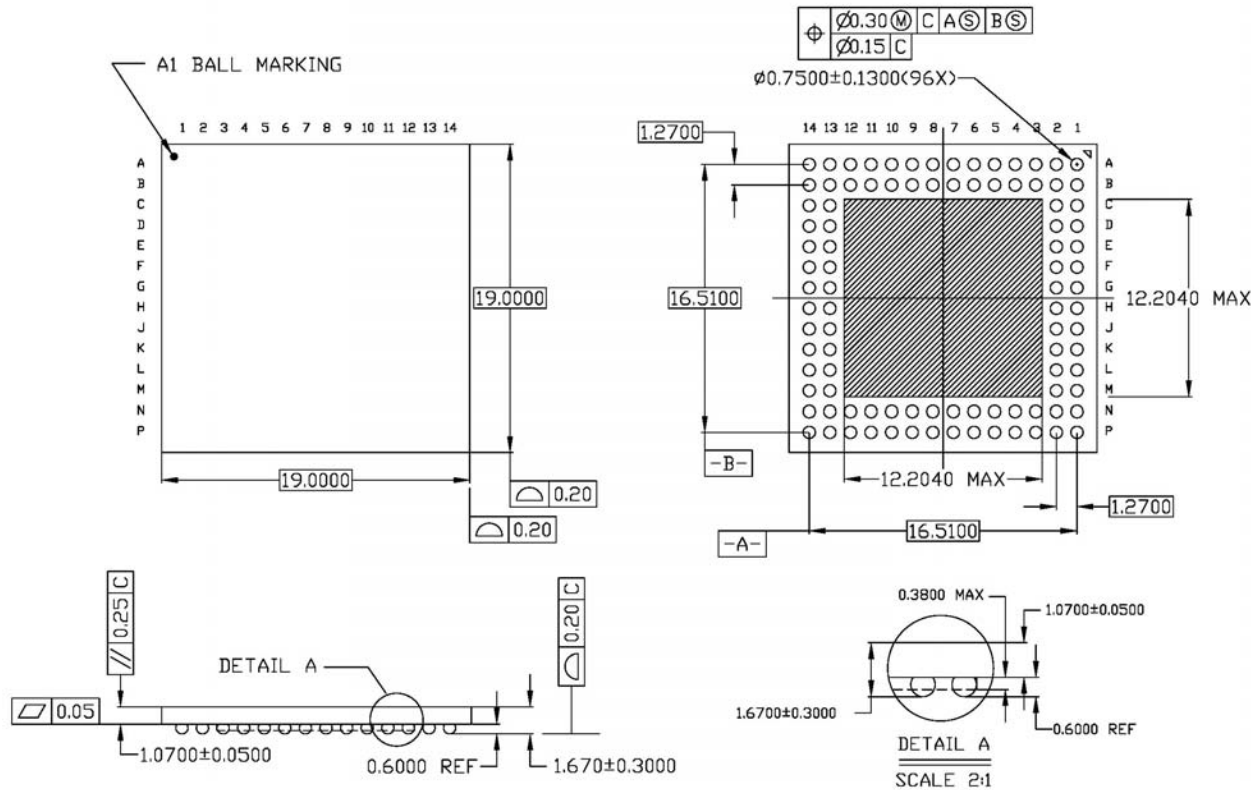
Single-ended drive, M14 (SLN) pin should be left floating and L14 (SLP) pin should be held low at +0.0V for normal operation, L14 (SLP) pin should be held high at +3.3V (CMOS) for standby mode.

Differential drive level requires external 100 ohm resistor between pins L14 (SLP) and M14 (SLN) and uses standard LVDS, (i.e. low level is 1.0V, high level is 1.4V). For normal mode M14 (SLN) is set low and L14 (SLP) is set high. For sleep mode M14 (SLN) is set high and L14 (SLP) is set low.

J. Do Not Connect Pins

Pins DNC1 (C1), DNC2 (D2), and DNC3 (M13) should be left floating. Connecting these pins to ground or to either supply voltage will alter device performance and may damage the part.

Figure 19: TC2411 96 Ball, Cavity-Down BGA Package Outline Dimensions (mm)



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